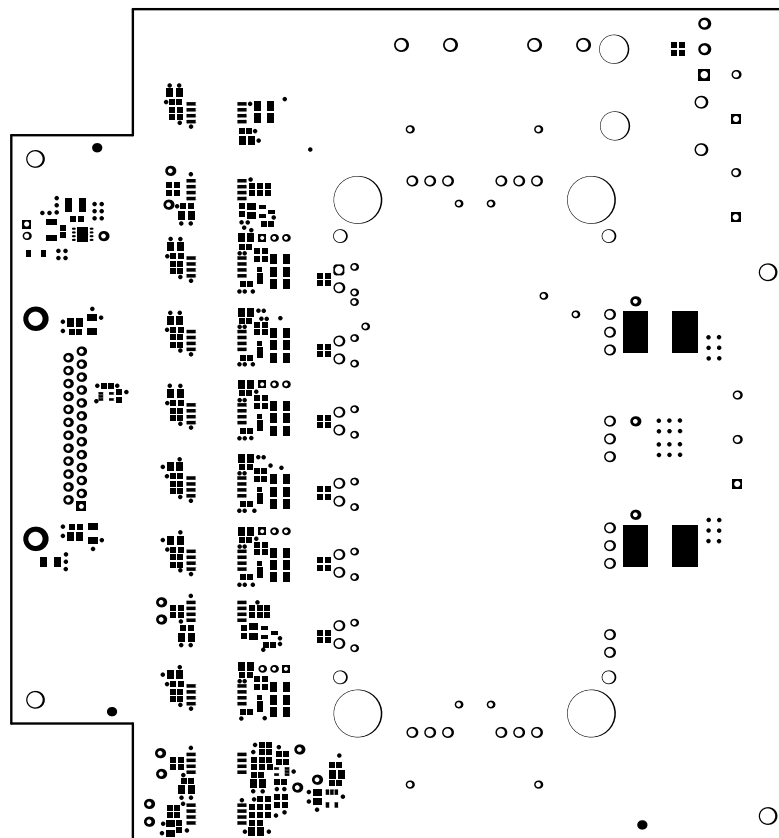
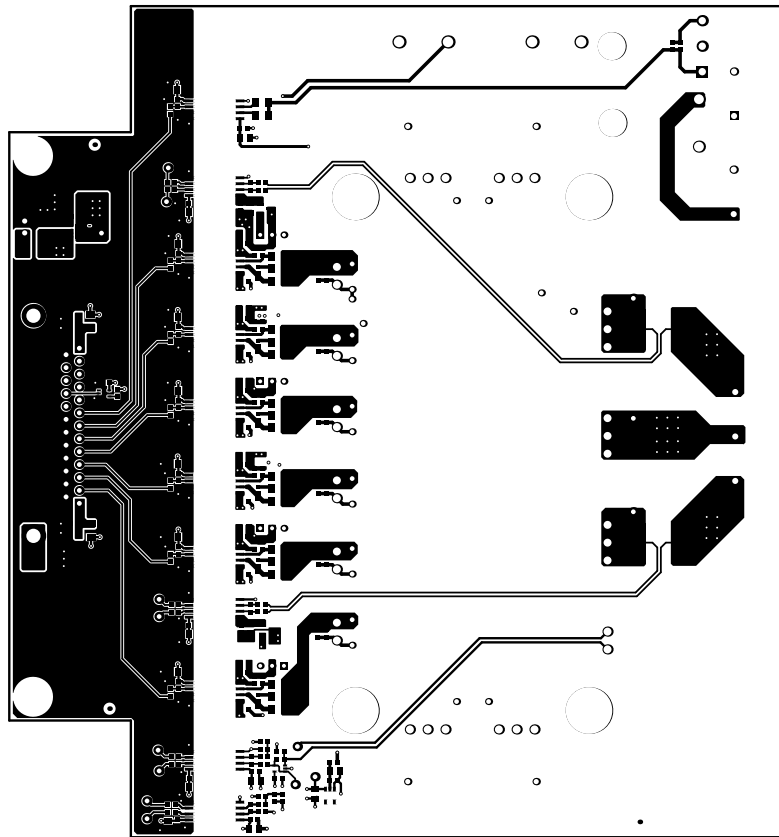


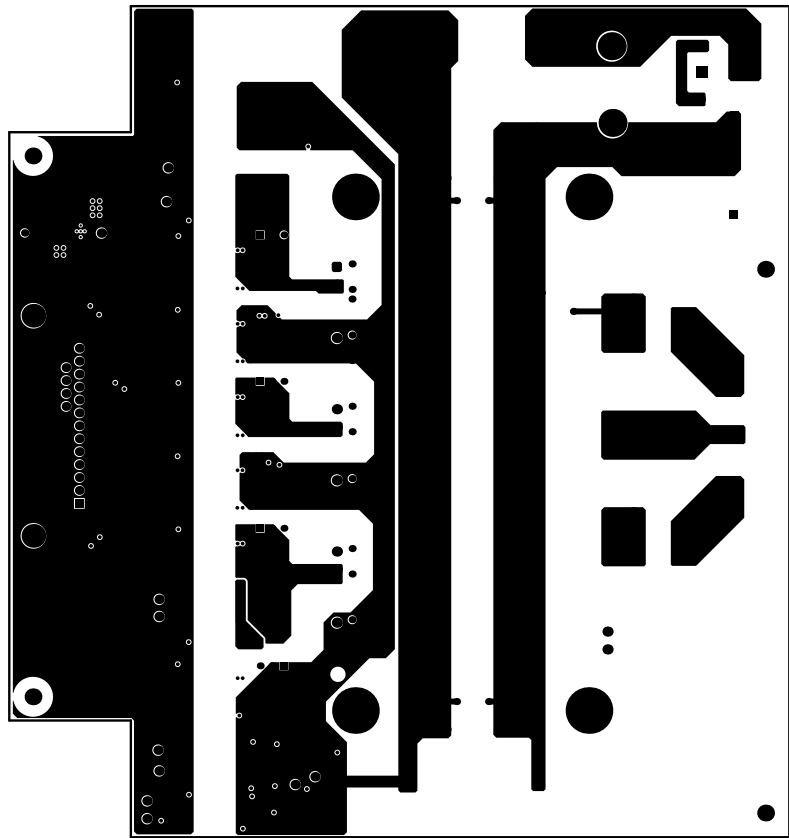
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00914	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00914		
Top Overlay	GENERATED : 3/30/2017	4:47:43 PM	TEXAS INSTRUMENTS



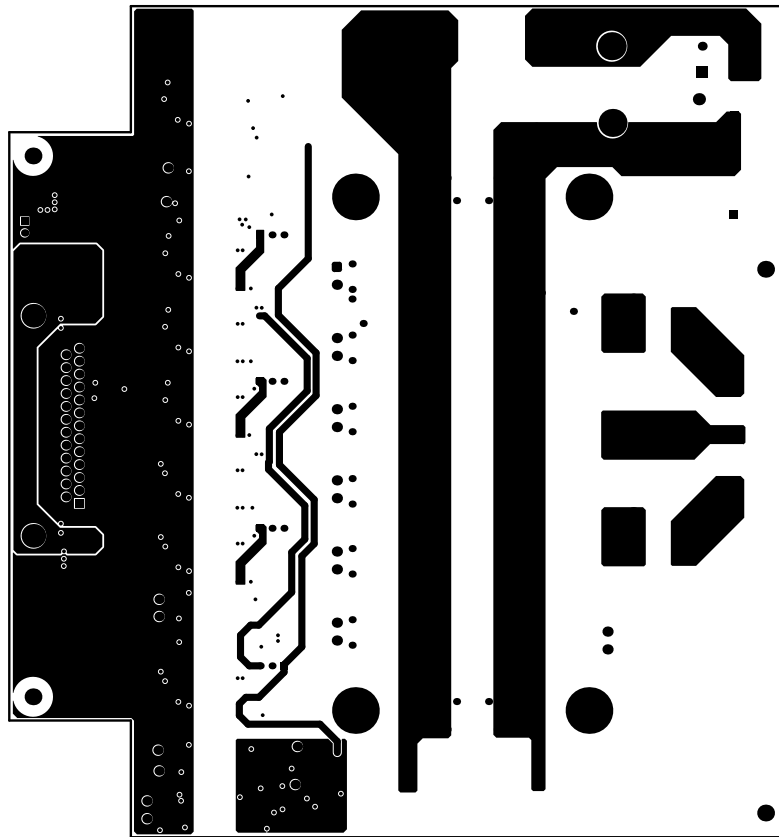
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00914	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00914		
Top Solder Mask	GENERATED : 3/30/2017	4:42:44 PM	TEXAS INSTRUMENTS



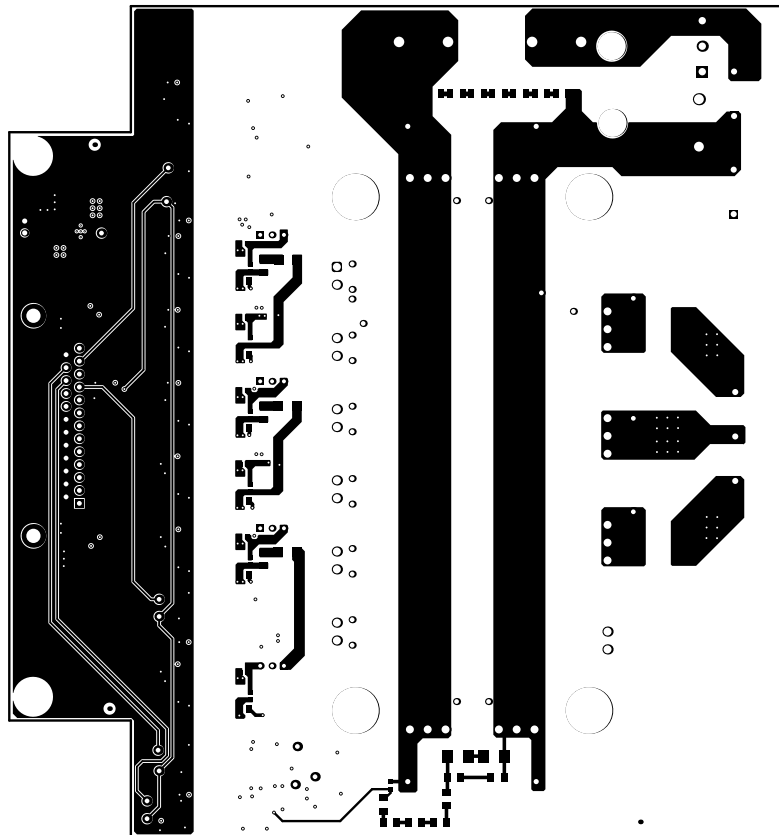
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00914	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-00914		
Top Layer	GENERATED : 3/30/2017	4:47:45 PM	TEXAS INSTRUMENTS



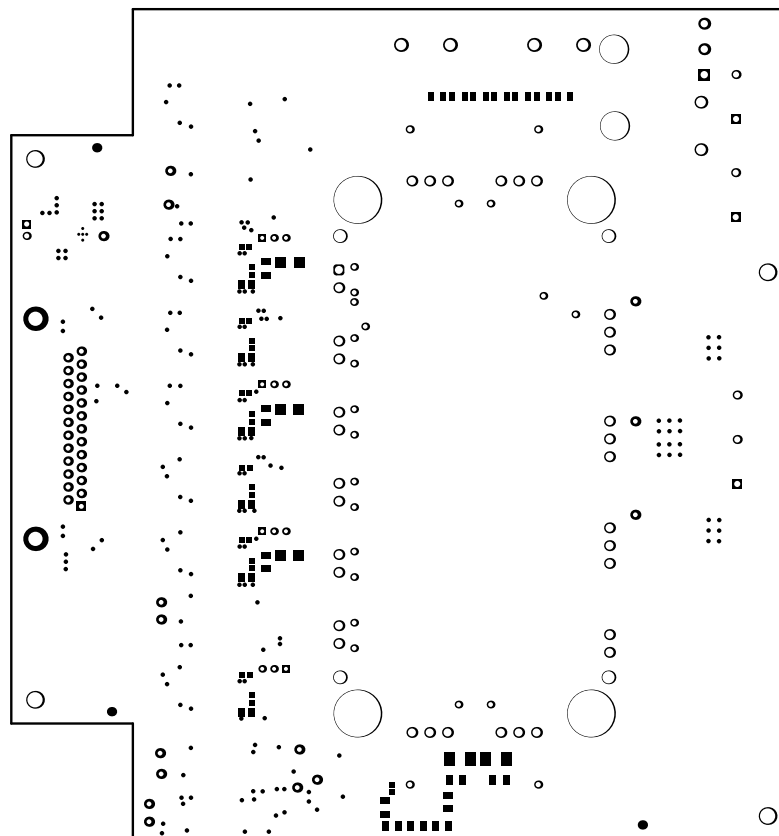
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00914	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = GND	TID #: TIDA-00914		
Signal 1	GENERATED : 3/30/2017	4:47:46 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00914	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = PWR	TID #: TIDA-00914		
Signal 2	GENERATED : 3/30/2017	4:47:47 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00914	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-00914		
Bottom Layer	GENERATED : 3/30/2017	4:47:48 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00914	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00914		
Bottom Solder Mask	GENERATED : 3/30/2017	4:47:49 PM	TEXAS INSTRUMENTS



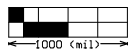
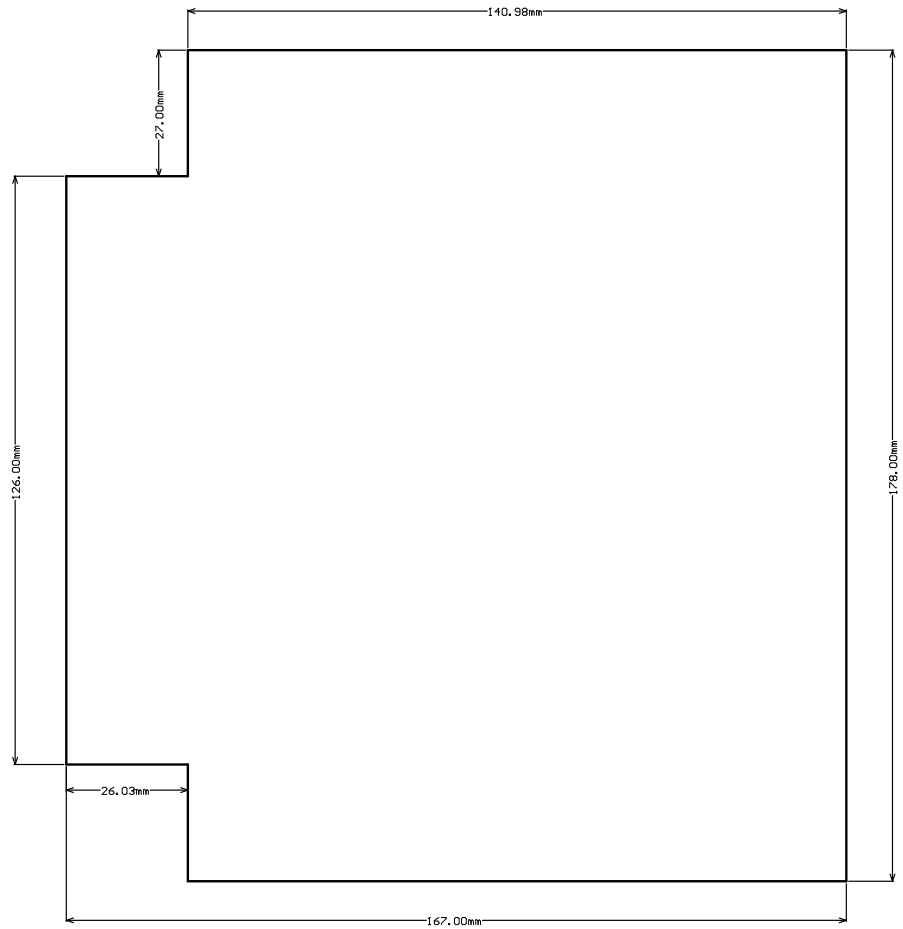


Symbol	Hit Count	Finished Hole Size	Plated	Hole Type
A	2	82.68mil (2.100mm)	PTH	Round
□	2	120.00mil (3.048mm)	PTH	Round
▽	2	236.22mil (6.000mm)	NPTH	Round
✕	3	62.00mil (1.575mm)	PTH	Round
☆	4	88.58mil (2.250mm)	PTH	Round
⊗	4	102.36mil (2.600mm)	NPTH	Round
★	4	128.00mil (3.251mm)	NPTH	Round
B	4	393.70mil (10.000mm)	NPTH	Round
D	5	7.87mil (0.200mm)	PTH	Round
✕	6	43.31mil (1.100mm)	PTH	Round
▽	7	51.18mil (1.300mm)	PTH	Round
⊙	12	33.46mil (0.850mm)	PTH	Round
○	25	41.00mil (1.041mm)	PTH	Round
■	35	40.00mil (1.016mm)	PTH	Round
◇	35	66.93mil (1.700mm)	PTH	Round
C	179	16.00mil (0.406mm)	PTH	Round
	329 Total			

Drill Table  
 FOR 7.87MIL DRILL +0/-2.87MIL  
 FOR 16MIL DRILL +0/-16MIL  
 FOR PTH DRILL +/-3MIL  
 FOR NPTH DRILL +/-2MIL



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00914	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00914		
Drill Drawing	GENERATED : 3/30/2017	4:42:51 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00914	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-00914		
Board Dimensions	GENERATED : 3/30/2017	4:47:52 PM	TEXAS INSTRUMENTS

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
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